

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Dynea Oy	03/11/2013
RECEIVING PARTY DATA	
Name:	Dynea AS
Street Address:	Svellevæien 33
City:	Lillestrøm
State/Country:	NORWAY
Postal Code:	2001
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13025187
CORRESPONDENCE DATA	
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<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
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Address Line 2:	Rembrandt Tower, 31st Floor
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ATTORNEY DOCKET NUMBER:	30780.0008.USP0
NAME OF SUBMITTER:	Coraline J. Haitjema
Signature:	/c j haitjema/
Date:	05/03/2013
Total Attachments: 6	

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REEL: 030341 FRAME: 0250

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ASSIGNMENT

For of the Invention known as **LOW FORMALDEHYDE EMISSION ADHESIVE SYSTEM**

THIS ASSIGNMENT is made the 11 day of MARCH 2013

BETWEEN,

DYNEA OY, Lautatarhankatu 6, 00580 Helsinki, Finland organised and existing under the laws of **FINLAND** (hereinafter called "the Assignor") of the one part, and

Dynea AS, Svellevæien 33, 2001 Lillestrøm, Norway organised and existing under the laws of the **NORWAY** (hereinafter called "the Assignee") of the other part.

WHEREAS

(A) The Assignor is the proprietor of each of the Patent(s) and Patent Application(s) listed in the attached schedule(s), and the invention(s) identified in the Patent(s) and/or Patent Application(s).

(B) The Assignor and Assignee have agreed that all the rights in the Patent(s), Patent Application(s) and invention(s) should be sold, assigned and transferred by the Assignor to the Assignee on the terms and for the consideration hereinafter set forth.

NOW THIS DEED WITNESSES

(1) Pursuant to the Agreement and in consideration of the sum of €1 now paid by the Assignee to the Assignor (the receipt whereof is hereby acknowledged) the Assignor with full title guarantee hereby sells, assigns and transfers to the Assignee:

the Patent(s) and Patent Application(s) listed in the attached schedule(s), the right, title, and interest therein and all the rights, powers, privileges and immunities arising or accrued therefrom, free from all encumbrances and including the right to claim priority under the Paris Convention, the right to be granted patent(s), the right to enforce the Patent(s) and to sue for damages and other remedies in respect of any infringement of the Patent(s) and Patent Application(s) including any infringement which may have occurred prior to the date hereof; and the invention(s) identified in the Patent(s) and/or Patent Application(s).

IN WITNESS whereof the parties hereto have caused this Deed of Assignment to be executed as a Deed and delivered on the day and year first above mentioned.

The Assignor agrees to promptly take any action required by the Assignee or its agents or assigns, to further the grant of the patent application(s) and any divisional application(s) filed, and the maintenance and enforcement of the (and any subsequently granted) patent(s) including in particular, the execution of any forms and the provision of any evidence.

It is hereby agreed that the terms of this assignment shall be interpreted under the laws of Finland and disputes arising under this agreement shall be adjudicated in Finland.

IN WITNESS whereof the parties hereto have caused this Deed of Assignment to be executed as a Deed and delivered on the day and year first above mentioned.

EXECUTED for and on behalf of **DYNEA OY** (the Assignor)

SIGNATURE OF ASSIGNOR: *[Signature]* *[Signature]*
Ilpo Koiristo *Kyösti Sitala*
Date: *11.03.2013* (dd.mm.yyyy)

STATEMENT OF WITNESS:

Signed at *Helsinki* (city) *Finland* (country)
on *11* (day) *03* (month) *2013* (year)

I, *Dr. Michael Grant* whose full residence address is
Bauerfeldg. 51P, 110 Vienna, Austria was
personally present and did see the person named above, *Ilpo Koiristo / Kyösti Sitala*
execute the above assignment on *11* (day) *03* (month) *2013* (year),
and such assignee is personally known to me to be the person described in this
assignment.

[Signature]
Signature of Witness

EXECUTED for and on behalf **Dynea AS** (the Assignee)

STATEMENT OF WITNESS:

SIGNATURE OF ASSIGNEE:

Date: 11.3.2013 TORJE BRØSTEN Kjellerfelt
(dd.mm.yyyy)

STATEMENT OF WITNESS:

Signed at Helsinki (city) Finland (country)

on 11 (day) 03 (month) 2013 (year)

I, Dr. Michael Gorn whose full residence address is
Bauernfeldg. 511 1190 Vienna, Austria was
personally present and did see the person named above, Torje Brøsten Kjellerfelt
execute the above assignment on 11 (day) 03 (month) 2013 (year),
and such assignor is personally known to me to be the person described in this
assignment.

[Signature]
Signature of Witness

For of the Invention known as **LOW FORMALDEHYDE EMISSION ADHESIVE SYSTEM**

SCHEDULE

Country	Patent Application No.	Publication No.	Filing Date yy.mm.dd	Assignor Ref.
GB	0814778.7		13-Aug-2008	10640
PCT	PCT/EP2009/060462	WO2010/018202	12-Aug-2009	10640
EP	09747798.8	2265684	12-Aug-2009	10640
AT	09747798.8	2265684	12-Aug-2009	10640
BE	09747798.8	2265684	12-Aug-2009	10640
BG	09747798.8	2265684	12-Aug-2009	10640
CN	200980140516.3	CN 102186942 A	12-Aug-2009	10640
DE	09747798.8	2265684	12-Aug-2009	10640
EE	09747798.8	2265684	12-Aug-2009	10640
ES	09747798.8	2265684	12-Aug-2009	10640
FI	09747798.8	2265684	12-Aug-2009	10640
FR	09747798.8	2265684	12-Aug-2009	10640
GB	09747798.8	2265684	12-Aug-2009	10640
ID	W-00201100912	W-00201100912	12-Aug-2009	10640
IT	09747798.8	2265684	12-Aug-2009	10640

LT	09747798.8	2265684	12-Aug-2009	10640
LV	09747798.8	2265684	12-Aug-2009	10640
NL	09747798.8	2265684	12-Aug-2009	10640
NO	09747798.8	2265684	12-Aug-2009	10640
PL	09747798.8	2265684	12-Aug-2009	10640
RO	09747798.8	2265684	12-Aug-2009	10640
RU	2011109219		12-Aug-2009	10640
SE	09747798.8	2265684	12-Aug-2009	10640
UA	201102749		12-Aug-2009	10640
US	13/758,058		04-Feb-2013	10640
US	13/025,187	US-2011-0198028-A1	11-Feb-2011	10640
VN	1-2011-00689		12-Aug-2009	10640